

60V N-Channel MOSFET

General Features

- Proprietary New Trench Technology
- $R_{DS(ON),typ.}\text{=}6.1~m\Omega@V_{GS}\text{=}10V$
- Low Gate Charge Minimize Switching Loss
- Fast Recovery Body Diode

Applications

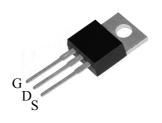
- High efficiency DC/DC Converters
- Synchronous Rectification
- **UPS** Inverter

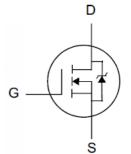
Ordering Information

Part Number	Package	Brand
PTP08N06NB	TO-220	1

Lead Free Package and Finish

BV _{DSS}	R _{DS(ON),typ.}	I _D ^[2]
60V	$6.1 m\Omega$	105A





TO-220

Package No to Scale

Absolute Maximum Ratings

T_C=25 [°]C unless otherwise specified

Symbol	Parameter	PTP08N06NB	Unit
V _{DSS}	Drain-to-Source Voltage ^[1]	60	V
V _{GSS}	Gate-to-Source Voltage	±20	v
	Continuous Drain Current TC = 25°C	105	
I _D	Continuous Drain Current ^{TC = 100°C}	73.5	
I _{DM}	Pulsed Drain Current at V _{GS} =10V ^[2,4]	420	A
lAs	Avalanche Current	30	
E _{AS}	Single Pulse Avalanche Energy	450	mJ
dv/dt	Peak Diode Recovery dv/dt ^[3]	5.0	V/ns
П	Power Dissipation	187.5	W
P _D	Derating Factor above 25℃	1.25	W/℃
T _L T _{PAK}	Maximum Temperature for Soldering Leads at 0.063in (1.6mm) from Case for 10 seconds, Package Body for 10 seconds	300 260	$^{\circ}$
T _J & T _{STG}	Operating and Storage Temperature Range	-55 to 175	

Caution: Stresses greater than those listed in the "Absolute Maximum Ratings" may cause permanent damage to the device.

Thermal Characteristics

Symbol	Parameter	PTP08N06A	Unit
R _{eJC}	Thermal Resistance, Junction-to-Case	0.8	20. 444
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient	62	°C/W



Electrical Characteristics

OFF Characteristics T_J =25°C unless otherwise specified

Symbol	Parameter	Min.	Тур.	Max.	Unit	Test Conditions
BV _{DSS}	Drain-to-Source Breakdown Voltage	60	-		٧	V _{GS} =0V, I _D =250uA
D	Drain to Course Leakage Current			1		V _{DS} =60V, V _{GS} =0V
I _{DSS}	Drain-to-Source Leakage Current			100		V_{DS} =48V, V_{GS} =0V, T_J =125°C
	Cato to Source Leakage Current			+100	nA	V _{GS} =+20V, V _{DS} =0V
I _{GSS}	Gate-to-Source Leakage Current			-100	I IIA	V _{GS} =-20V, V _{DS} =0V

ON Characteristics

T_J =25 °C unless otherwise specified

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Symbol	Parameter	Min.	Тур.	Max.	Unit	Test Conditions
R _{DS(ON)}	Static Drain-to-Source On-Resistance		6.1	7.5	mΩ	V _{GS} =10V, I _D =50A ^[5]
$V_{\text{GS(TH)}}$	Gate Threshold Voltage	2.0		4.0	V	$V_{DS}=V_{GS}$, $I_{D}=250uA$
gfs	Forward Transconductance		50		S	VDS=10V,ID=25A [5]

Dynamic Characteristics

Essentially independent of operating temperature

Symbol	Parameter	Min.	Тур.	Max.	Unit	Test Conditions
C _{iss}	Input Capacitance		3800			\/ -0\/
C _{rss}	Reverse Transfer Capacitance		380		pF	V_{GS} =0V, V_{DS} =25V, f =1.0MH $_{Z}$
C _{oss}	Output Capacitance		298			
Q_g	Total Gate Charge		70			
Q _{gs}	Gate-to-Source Charge		25		nC	V_{DD} =30V, I_{D} =55A, V_{GS} =0 to 10V
Q_{gd}	Gate-to-Drain (Miller) Charge		14			

Resistive Switching Characteristics

Essentially independent of operating temperature

Symbol	Parameter	Min.	Тур.	Max.	Unit	Test Conditions
td(ON)	Turn-on Delay Time		25			
trise	Rise Time		12		nS	V_{DD} =30V, I_{D} =55A,
td(OFF)	Turn-Off Delay Time		38			V_{GS} = 10V R _G =2.5Ω
t fall	Fall Time		10			



Source-Drain Body Diode Characteristics

 T_J =25 $^{\circ}$ C unless otherwise specified

Symbol	Parameter	Min	Тур.	Max.	Unit	Test Conditions
I _{SD}	Continuous Source Current ^[2]		I	105	۸	Integral PN-diode in
I _{SM}	Pulsed Source Current ^[2]			420	Α	MOSFET
V _{SD}	Diode Forward Voltage		-	1.2	V	I _S =30A, V _{GS} =0V
trr	Reverse recovery time		45		ns	V _{GS} =0V ,I _F =30A,
Qrr	Reverse recovery charge		55		nC	dir/dt=100A/μs

Note:

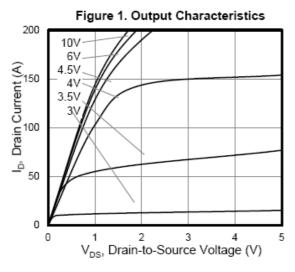
^[1] T_J=+25℃ to +175℃

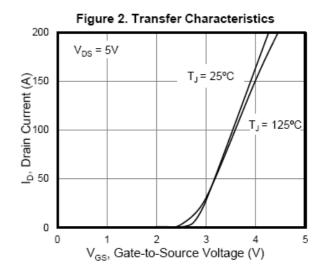
^[2] Silicon limited current only.
[3].Package limited current

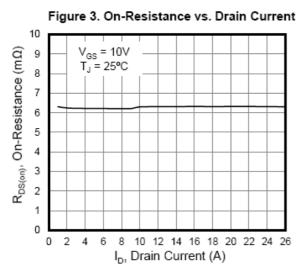
^[4] Repetitive rating; pulse width limited by maximum junction temperature. [5] Pulse width≤380µs; duty cycle≤2%.

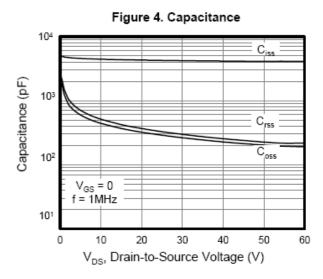


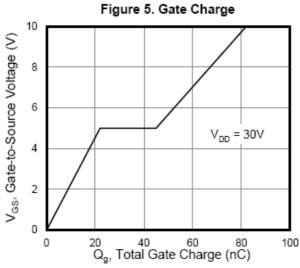
Typical Characteristics

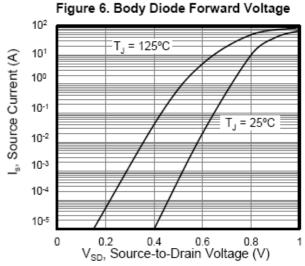














Typical Characteristics(Cont.)

Figure 7. On-Resistance vs.

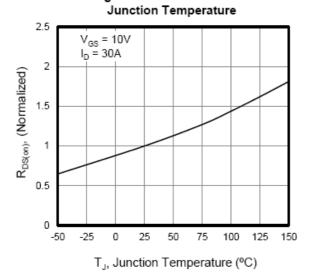
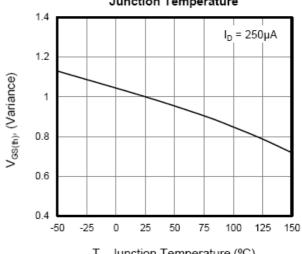


Figure 8. Threshold Voltage vs. Junction Temperature



T_J, Junction Temperature (°C)

Figure 9. Transient Thermal Impedance

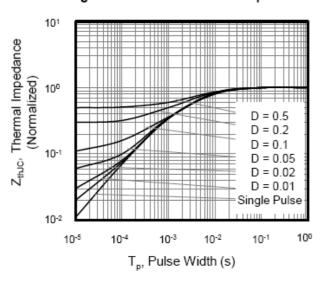
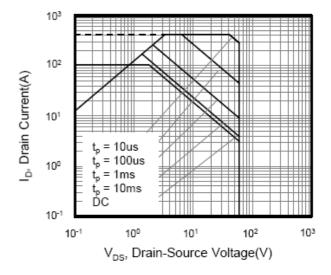


Figure 10. Safe operation area





Test Circuits and Waveforms

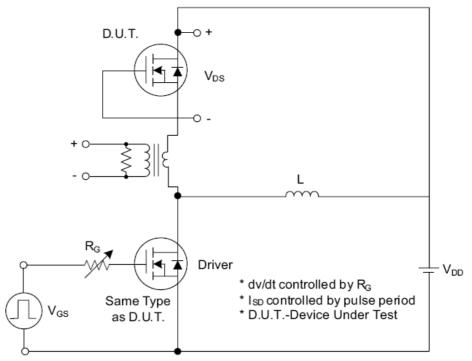


Fig. 1.1 Peak Diode Recovery dv/dt Test Circuit

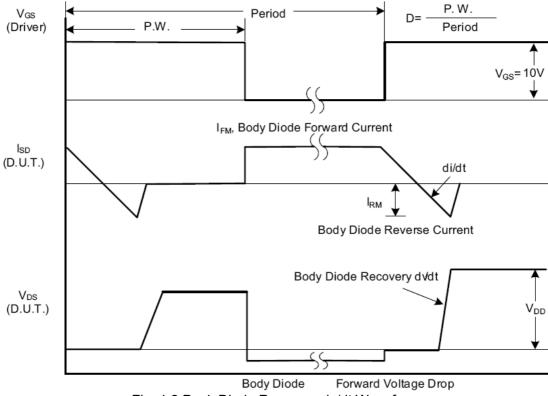


Fig. 1.2 Peak Diode Recovery dv/dt Waveforms



Test Circuits and Waveforms (Cont.)

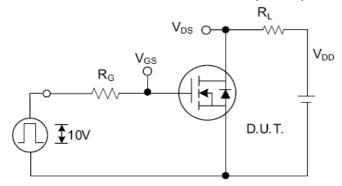


Fig. 2.1 Switching Test Circuit

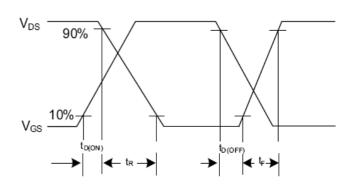


Fig. 2.2 Switching Waveforms

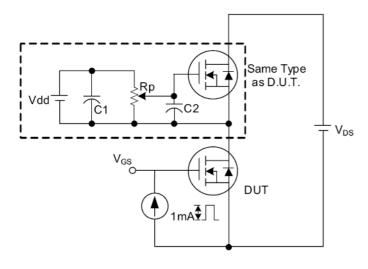


Fig. 3 . 1 Gate Charge Test Circuit

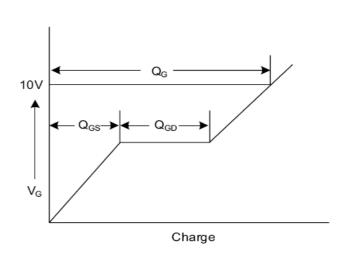


Fig. 3.2 Gate Charge Waveform

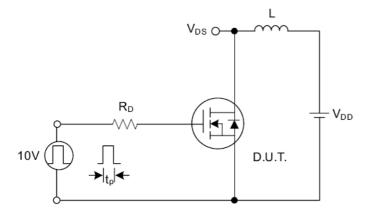


Fig. 4.1 Unclamped Inductive Switching Test Circuit

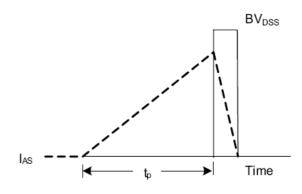


Fig. 4.2 Unclamped Inductive Switching Waveforms



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